DISCRETE SEMICONDUCTORS



Product specification Supersedes data of June 1993 File under Discrete Semiconductors, SC09 1996 May 08



Philips Semiconductors

## BGY135; BGY136

#### FEATURES

- 12.5 V nominal supply voltage
- 18 W output power.

#### APPLICATIONS

• Mobile communication equipment operating directly from 12 V vehicle electrical systems.

#### DESCRIPTION

The BGY135 and BGY136 are two-stage broadband RF amplifier modules in a SOT132B package. Each module consists of two NPN transistor dies together with lumped-element matching components.

PIN	DESCRIPTION
1	RF input
2	ground
3	V <sub>S1</sub>
4	ground
5	V <sub>S2</sub>
6	ground
7	RF output
Flange	ground

**PINNING - SOT132B** 



#### QUICK REFERENCE DATA

TYPE NUMBER	MODE OF OPERATION	f (MHz)	V <sub>S1</sub> ; V <sub>S2</sub> (V)	P <sub>D</sub> (mW)	P <sub>L</sub> (W)	Z <sub>S</sub> ; Z <sub>L</sub> (Ω)
BGY135	CW	132 to 156	12.5	12.5 150	≥18	50
BGY136	CW	146 to 174	12.5	150	≥10	50

WARNING
Product and environmental safety - toxic materials
This product contains beryllium oxide. The product is entirely safe provided that the BeO inserts are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

# BGY135; BGY136

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V <sub>S1</sub>	DC supply voltage	-	15.6	V
V <sub>S2</sub>	DC supply voltage	-	15.6	V
Vi	RF input voltage	-	25	V
Vo	RF output voltage	-	25	V
P <sub>D</sub>	input drive power	-	300	mW
PL	load power	-	25	W
T <sub>stg</sub>	storage temperature	-40	+100	°C
T <sub>h</sub>	heatsink operating temperature	-20	+90	°C



## BGY135; BGY136

### CHARACTERISTICS

 $Z_S$  =  $Z_L$  = 50  $\Omega;$   $P_D$  = 150 mW;  $V_{S1}$  =  $V_{S2}$  = 12.5 V;  $T_h$  = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
f	frequency					
	BGY135		132	-	156	MHz
	BGY136		146	-	174	MHz
I <sub>Q2</sub>	leakage current	$V_{S1} = 0; P_D = 0$	_	-	1	mA
PL	load power		18	-	_	W
η	efficiency	adjust $P_D$ for $P_L = 18 W$	38	45	-	%
H <sub>2</sub>	second harmonic	adjust $P_D$ for $P_L = 18 W$	_	_	-25	dBc
H <sub>3</sub>	third harmonic	adjust $P_D$ for $P_L = 18 W$	-	-	-25	dBc
VSWR <sub>in</sub>	input VSWR	adjust $P_D$ for $P_L = 18 W$	-	1.5	3	
	stability	$V_{S1} = V_{S2} = 10.8 \text{ to } 15.6 \text{ V};$ $P_L = 2 \text{ to } 20 \text{ W}; \text{ VSWR} = 3 : 1$	-	-	-60	dBc
	ruggedness	$\label{eq:P_D} \begin{array}{l} {P_{D}} \le 300 \text{ mW}; \\ {V_{S1}} = {V_{S2}} = 15.6 \text{ V duration 5 s}; \\ {P_{L}} < 25 \text{ W}; \text{ VSWR} = 50 : 1 \end{array}$	no degradation			





## BGY135; BGY136



MRC260

## VHF power amplifier modules

## BGY135; BGY136

160

170

f (MHz)

MRC263

146 MHz

174 MHz

25

50

75

T<sub>mb</sub> (°C)

100

180



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#### Test circuit information





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### List of components (see Fig.13)

COMPONENT	DESCRIPTION	VALUE	CATALOGUE NO
C1, C5	multilayer chip capacitor	1 nF	4822 590 06614
C2, C6	tantalum capacitor	6.8 μF, 35 V	2022 001 00067
C3, C7	multilayer chip capacitor	10 nF	2222 852 47103
C4, C8	multilayer chip capacitor	100 nF	2222 852 47104
L1, L2	1 turn 0.5 mm copper wire on ferrite coil	1 μΗ	3122 108 20153
Z <sub>1</sub> , Z <sub>2</sub>	stripline; note 1	50 Ω	

#### Note

1. The striplines are on a double copper-clad printed-circuit board, with epoxy dielectric ( $\epsilon_r = 4.7$ ), thickness  $\frac{1}{16}$  inch.

# BGY135; BGY136

### PACKAGE OUTLINE



#### Product specification

### BGY135; BGY136

#### DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				
Where application information is given, it is advisory and does not form part of the specification.				

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.